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DEPT.	For 2.00 mm (.079") Pin Header of System CH72	PAGE:	1/3

1. SCOPE:

This specification contains the test requirement of subject pin headers when tested under the condition and

below standards base on CviLux test procedure

2. APPLICABLE STANDARDS:

MIL - STD - 202 Methods for test of connectors for electronic equipment

MIL - STD - 1344 Test methods for electrical connectors

JIS - C - 5402 Methods for test of connectors for electronic equipment

UL 94 Test for flammability of plastic materials for parts in devices and

appliance

3. APPLICABLE SERIES NO.: CH72 SERIES

4. SHAPE, CONSTRUCTION AND DIMENSIONS

See attached drawings

5. MATERIALS

See attached drawings

6. ACCOMMODATED P.C.BOARD

(P.C. Board on which the Pin Header are installed), 0.8 mm (.031") ~ 1.6 mm (.063")



REVIEWED: <u>Alex</u> APPROVED: <u>David</u> VERIFIED: <u>Sun</u>.



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## 7. ELECTRICAL PERFORMANCE:

	ITEM	TEST CONDITION	
7.1	Rated current and voltage		1A 250V AC (r.m.s.)
7.2	Contact resistance	Dry circuit of DC 20 mV max., 100 mA max.	Less than 20 m $\Omega$
7.3	Dielectric strength	When applied AC 1000 V 1minute between adjacent terminal	No change
7.4	Insulation resistance	When applied DC 500 V between adjacent terminal or ground	More than $1000 \text{ M}\Omega$

## 8. MECHANICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
8.1	Pin retention force	Push pin from insulator base at speed	More than 0.8 Kgf
		25± 3 mm per minute	

## 9. ENVIRONMENTAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
9.1	Solderability	Soldering time: 5 ± 0.5 second	Minimum:
		Soldering pot: 230 ± 5°C	90% of immersed area
9.2	Resistance to soldering	Insulator : Glass filled polyester UL 94V-0	No damage
	heat	Soldering time: $5 \pm 0.5$ second	
		Soldering pot: 260 ± 5°C	
		Insulator : Nylon 6T	
		Max. Infrared Reflow Soldering temperature & time:	
		230°C for 60 Sec.	
		260°C for 10 Sec.	
9.3	Heat aging	105± 2°C, 96 hours	No damage
9.4	Humidity	40± 2°C, 90-95% RH, 96 hours measurement must be taken within 30 min.	Appearance: No damage Contact resistance:
		after tested	Less than twice of initial Dielectric strength:
			To pass para 7-3
9.5	Temperature cycling	One cycle consists of:	Appearance: No damage
		$(1)-55 + 0 \circ C$ , 30 min.	Contact resistance:
		(2)Room temp. 10-15 min.	Less than twice of initial
		(3) $85^{+3}_{-0}$ °C, 30 min.	
		(4)Room temp. 10-15 min.	



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	ITEM	TEST CONDITION	REQUIREMENT
9.6	Salt spray	Temperature: 35± 3°C	Appearance: No damage
		Solution: 5± 1%	Contact resistance:
		Spray time: 48± 4 hours	Less than twice of initial
		Measurement must be taken after water	
		rinse	

## 10. AMBIENT TEMPERATURE RANGE:

-40 to  $+105\,^{\circ}\text{C}$ ;  $+215\,^{\circ}\text{C}$  intermittent (Vapor Phase Solder Reflow) for SMT type